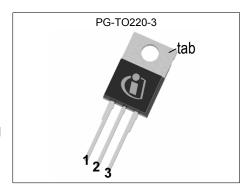


MOSFET

600V CoolMOS™ CM8 Power Transistor

The CoolMOS™ 8th generation platform is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The 600V CoolMOS™ CM8 series is the successor to the CoolMOS™ 7. It combines the benefits of a fast switching SJ MOSFET with excellent ease of use, e.g low ringing tendency, implemented fast body diode (CFD) for all products with outstanding robustness against hard commutation and excellent ESD capability. Furthermore, extremely low switching and conduction losses of CM8, make switching applications even more efficient.



Features

- Suitable for hard and soft switching topologies thanks to an outstanding commutation ruggedness
- Significant reduction of switching and conduction losses
- Best in class R_{DS(on)} per package products enabled by ultra low R_{DS(on)}*A

Benefits

- Ease of use and fast design-in through low ringing tendency and usage across PFC and PWM stages
- Simplified thermal management thanks to our advanced die attach technique
- Increased power density solutions enabled by using products with smaller footprint and higher manufacturing quality due state of the art ESD protection
- Suitable for a wide variety of applications and power ranges

Potential applications

- Power supplies and converters
- PFC stages & LLC resonant converters
- High efficiency switching applications
- e.g. Server, Telecom, EV Charging, UPS

Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

rabio i regitarioni and i aramotoro							
Parameter	Value	Unit					
V _{DS} @ T _{j,max}	650	V					
R _{DS(on),max}	16	mΩ					
$Q_{g,typ}$	171	nC					
I _{D,pulse}	505	A					
E _{oss} @ 400V	22.9	μJ					
Body diode di _F /dt	1300	A/µs					
ESD class (HBM)	2	-					

Type / Ordering Code	Package	Marking	Related Links
IPP60R016CM8	PG-TO220-3	60R016C8	see Appendix A

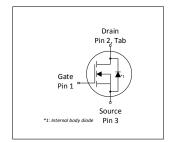












Table of Contents

Description
Maximum ratings 3
Thermal characteristics
Electrical characteristics 5
Electrical characteristics diagrams
Test Circuits
Package Outlines
Appendix A
Revision History
Trademarks
Disclaimer

600V CoolMOS™ CM8 Power Transistor IPP60R016CM8



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Davamatav	Values				11	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	135 85	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	505	Α	T _C =25°C	
Avalanche energy, single pulse	E _{AS}	-	-	297	mJ	I_D =10.1A; V_{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	1.48	mJ	I_D =10.1A; V_{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	10.1	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	625	W	<i>T</i> _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Extended operating junction temperature	T _j	150	-	175	°C	≤50 h in the application lifetime	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	135	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	505	Α	<i>T</i> _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ ≤135A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _F /dt	-	-	1300	A/µs	A/ μ s V_{DS} =0400V, I_{SD} ≤135A, T_{j} =25 see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Limited by $T_{j,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$





2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Davamatav	Cumbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.2	K/W	-
Thermal resistance, junction - ambient		-	-	62	K/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	K/W	-
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

600V CoolMOS™ CM8 Power Transistor IPP60R016CM8



3 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Ol	Values				Note / Total Constitution	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V _{GS} =0V, I _D =1mA	
Gate threshold voltage	V _{(GS)th}	3.7	4.2	4.7	V	$V_{DS}=V_{GS}, I_{D}=1.48\text{mA}$	
Zero gate voltage drain current	I _{DSS}	-	- 244	2 -	μA	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C	
Gate-source leakage current	I _{GSS}	-	-	0.1	μA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.013 0.028	0.016	Ω	V _{GS} =10V, I _D =62.5A, T _j =25°C V _{GS} =10V, I _D =62.5A, T _j =150°C	
Gate resistance	R _G	-	1	-	Ω	f=1MHz	

Table 5 **Dynamic characteristics**

Demonstra	Or week all		Values			N / / T / O 11/1
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	7545	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Output capacitance	Coss	-	91	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	286	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	2976	-	pF	I _D =constant, V _{GS} =0V, V _{DS} =0400V
Turn-on delay time	t _{d(on)}	-	29.4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =29.7A, $R_{\rm G}$ =1.8Ω; see table 9
Rise time	t _r	-	16	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =29.7A, $R_{\rm G}$ =1.8Ω; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	125.7	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =29.7A, $R_{\rm G}$ =1.8 Ω ; see table 9
Fall time	t _f	-	4.4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =29.7A, $R_{\rm G}$ =1.8 Ω ; see table 9

Table 6 **Gate charge characteristics**

Parameter	Cy smale al		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	45	-	nC	V_{DD} =400V, I_{D} =29.7A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	61	-	nC	V_{DD} =400V, I_{D} =29.7A, V_{GS} =0 to 10V
Gate charge total	Qg	-	171	-	nC	V_{DD} =400V, I_{D} =29.7A, V_{GS} =0 to 10V
Gate plateau voltage	$V_{ m plateau}$	-	5.9	-	V	V_{DD} =400V, I_{D} =29.7A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

IPP60R016CM8

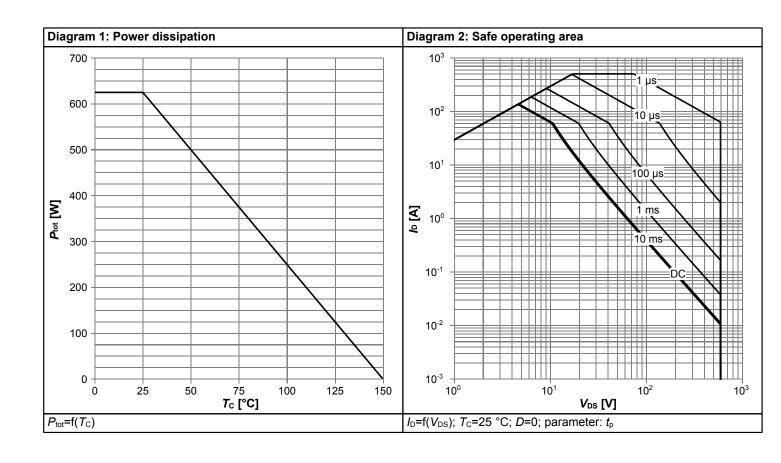


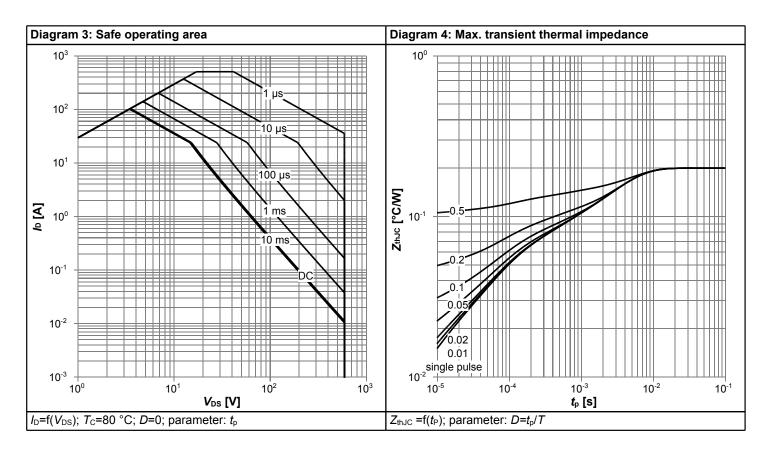
Table 7 Reverse diode characteristics

Parameter	Cymphal	Values			11:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =29.7A, T _j =25°C
Reverse recovery time	t _{rr}	-	180	225	ns	V_R =400V, I_F =29.7A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	1.54	2.31	μC	V_R =400V, I_F =29.7A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	_	16.4	_	А	V_R =400V, I_F =29.7A, di_F/dt =100A/ μ s; see table 8

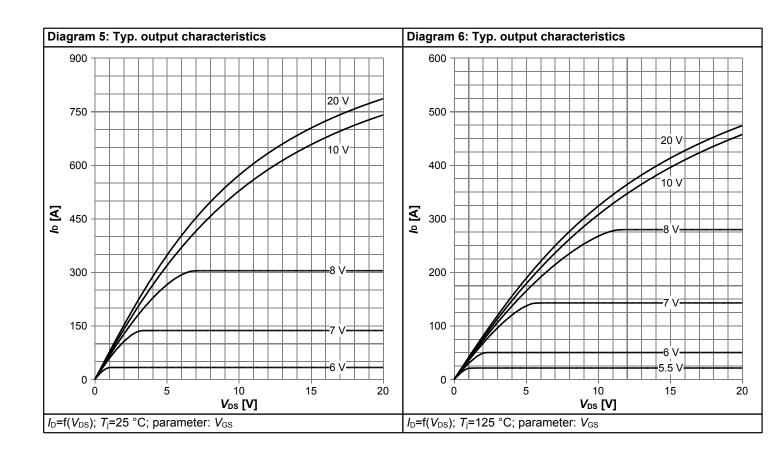


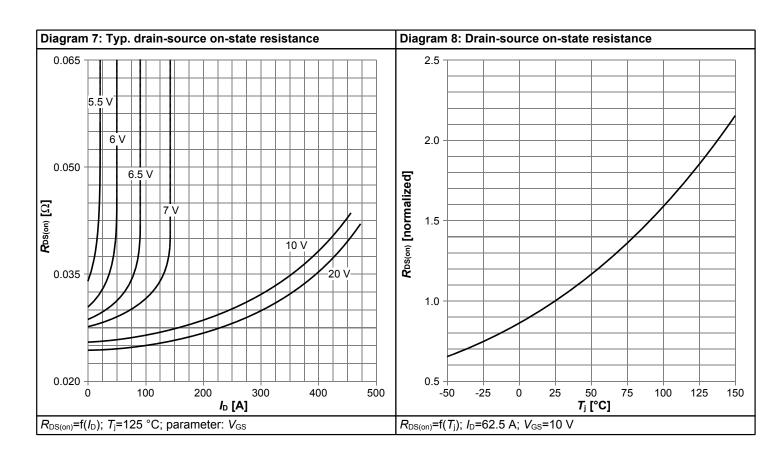
4 Electrical characteristics diagrams



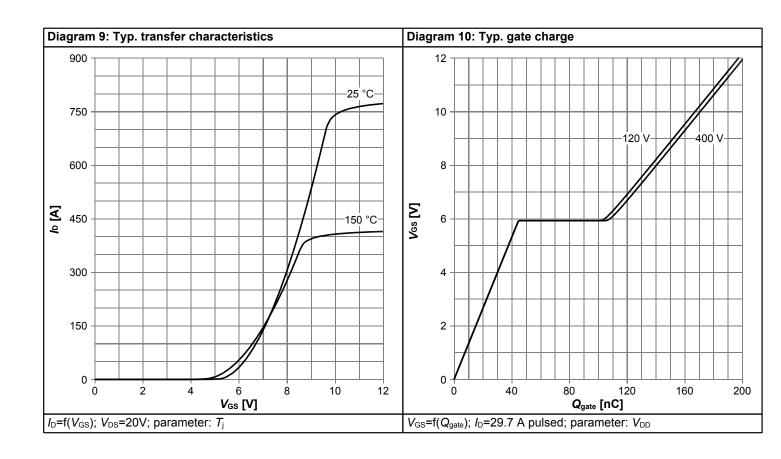


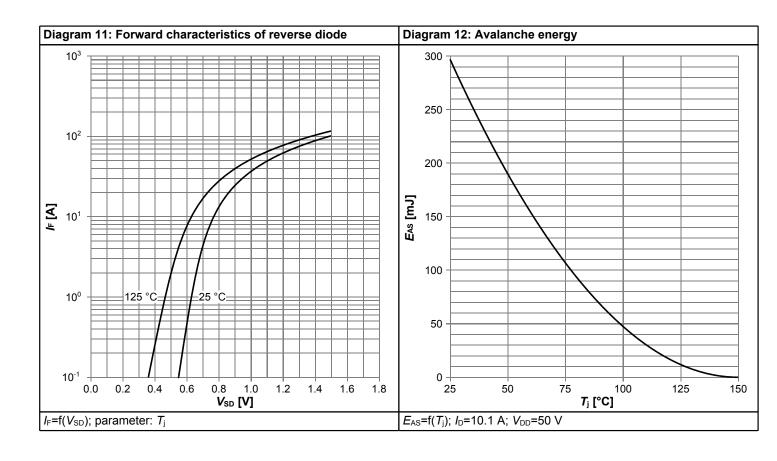




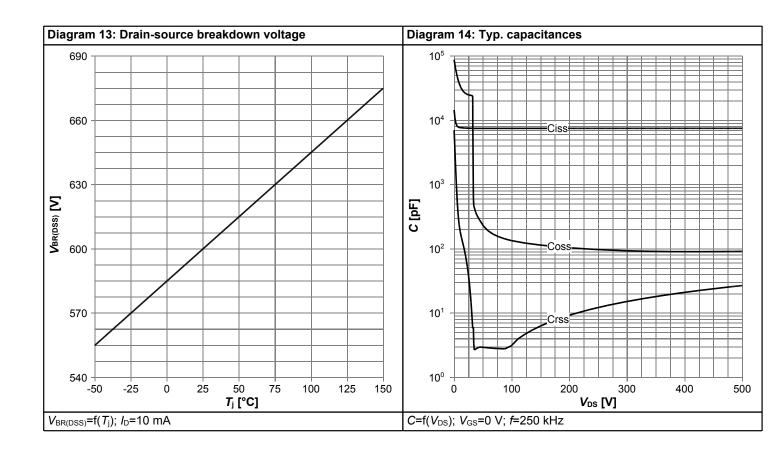


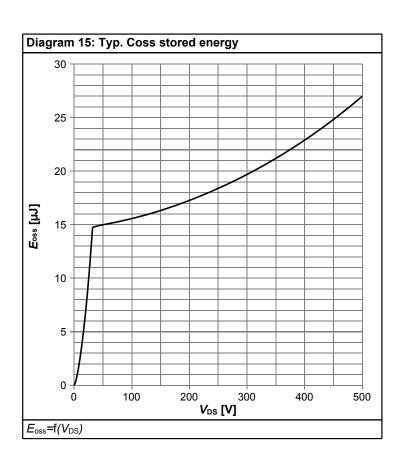










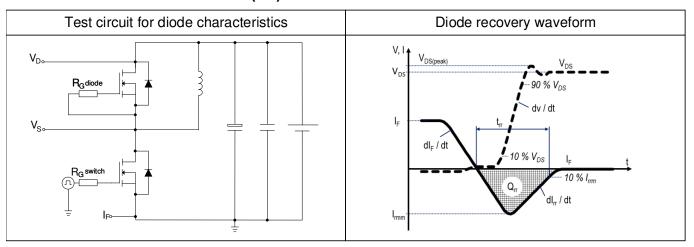


IPP60R016CM8

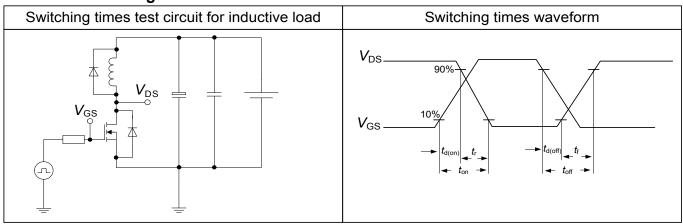


5 **Test Circuits**

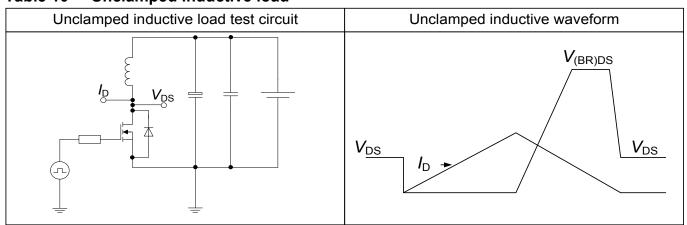
Table 8 **Diode characteristics (C8)**



Switching times Table 9



Unclamped inductive load Table 10





6 Package Outlines

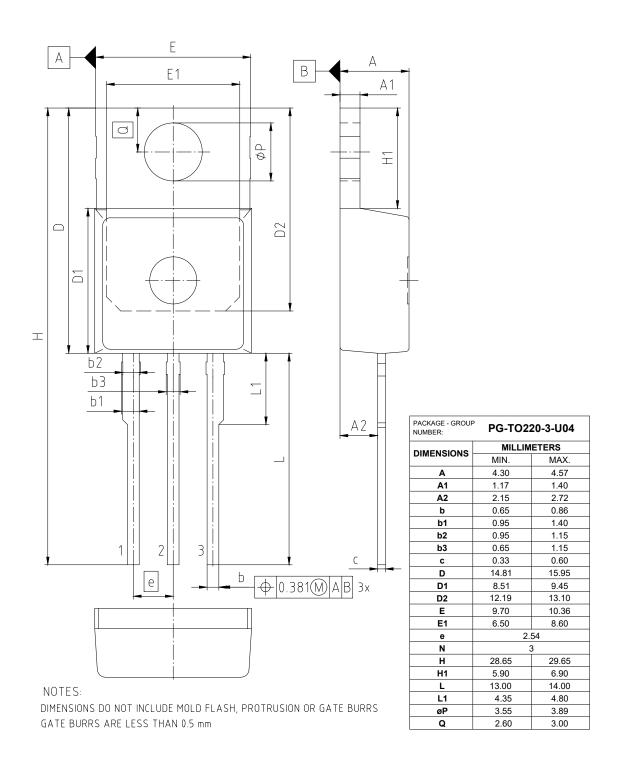


Figure 1 Outline PG-TO220-3, dimensions in mm

600V CoolMOS[™] CM8 Power Transistor IPP60R016CM8



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CM8 Webpage: www.infineon.com

• IFX CoolMOS CM8 application note: www.infineon.com

• IFX CoolMOS CM8 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPP60R016CM8



Revision History

IPP60R016CM8

Revision: 2024-03-21, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-09-26	Release of final version
2.1	2023-10-14	Update of switching times
2.2	2024-03-21	Update of R _{thJC}

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2023 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Final Data Sheet 14 Rev. 2.2, 2024-03-21